

Enhancement Mode P-Channel Power MOSFET

SOT23/PMOS/- $60V/\pm20V/-2V/-2A/140m\Omega$

Rev1.1





P Channel Advanced Power MOSFET

1.Features

- ◆ Fast Switching
- ◆ Improved dv/dt Capability

V _{DS}	R _{DS(on)} Typ.	I _D Max.
-60V	140mΩ @ 10V	-2A

2.Applications

- ◆ Load Switch
- PWM Application
- Power management



Schematic Diagram

3. Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.	
WP2309	N9	SOT23	3,000	180,000	

4. Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Value	Units	
Drain to Source Voltage	V _{DS}	-60	V	
Gate to Source Voltage	V _G s	±20	V	
Drain Current (DC)	ID	-2	А	
Drain Current (Pulse), PW≤300μs	I _{DP}	-8	А	
Total Dissipation	P _D	1	W	
Junction Temperature	Tj	150	°C	
Storage Temperature	T _{stg}	-55 to +150	°C	

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit	
Junction to ambient	Reja	125	°C/W	

Note 2: When mounted on 1 inch square copper board t ≤ 10sec The value in any given application depends on the user's specific board design.

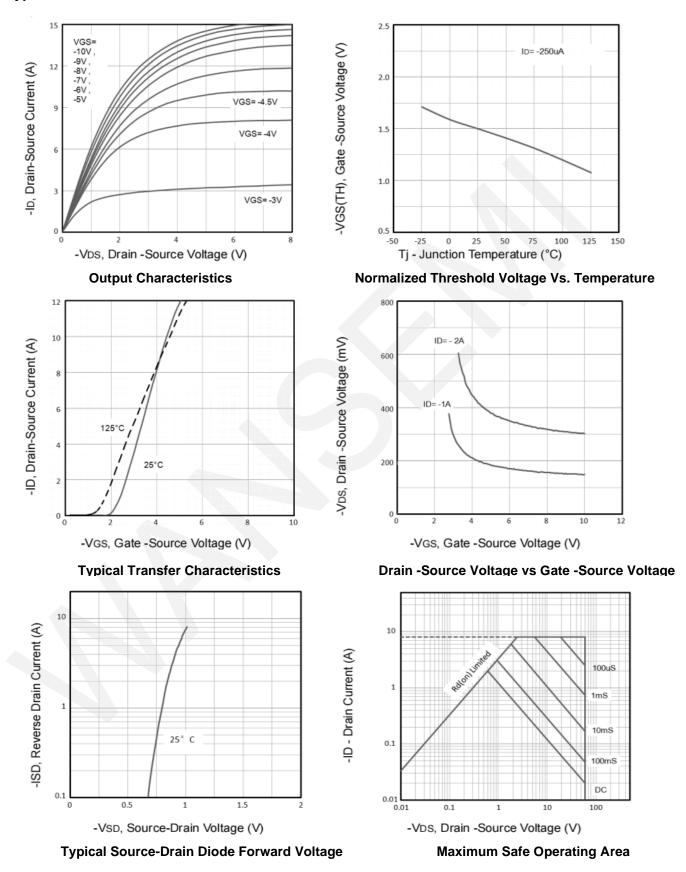
6.Electrical Characteristics at Ta=25°C (Note 3)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \mu A$, $V_{GS} = 0 V$	-60			V
Zero-Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60V, V_{GS} = 0V$			-1	μΑ
Gate to Source Leakage Current	Igss	V _{GS} = ±20V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _{DS} =250μA	-1.4	-2.0	-2.6	V
Static Drain to Source On-State Resistance	R _{DS(on)}	I _D = -2A, V _{GS} = -10V	-	140	190	mΩ
Input Capacitance	Ciss	V -0V		310		pF
Output Capacitance	C _{oss}	V _{GS} =0V, V _{DS} =-30V,		22		pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz		15		pF
Turn-ON Delay Time	t _{d(on)}	I_D = -2A, V_{DS} =-30V, R_{GEN} = 3.3 Ω , V_{GS} =-10V,		41		ns
Rise Time	tr			22		ns
Turn-OFF Delay Time	t _{d(off)}			25		ns
Fall Time	t _f			32		ns
	Qg	V _{DS} = -30V, V _{GS} =-10V, I _D = -2A		5.4		nC
Total Gate Charge	Qgs			1.1		nC
	Q _{gd}			1.6		nC
Diode Forward Voltage	V _{FSD}	I _{SD} = -2A,V _{GS} =0V		-0.8	-1.2	V

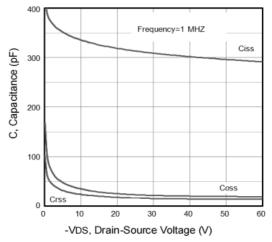
Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



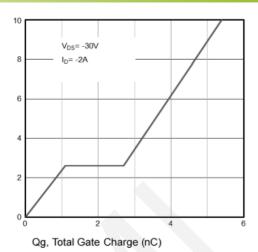
7. Typical electrical and thermal characteristics





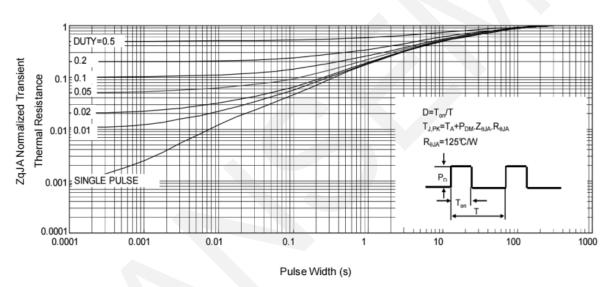


-VGS, Gate-Source Voltage (V)



Typical Capacitance Vs. Drain-Source Voltage

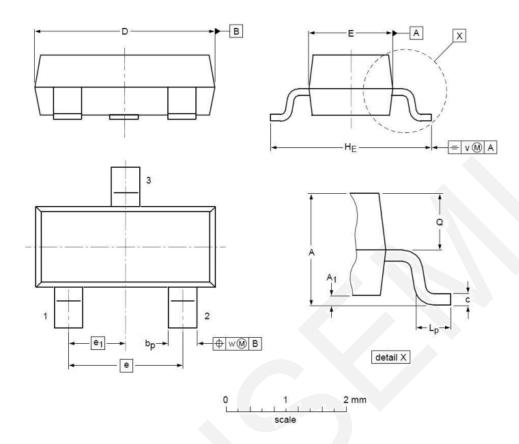
Typical Gate Charge Vs. Gate-Source Voltage



Normalized Maximum Transient Thermal Impedance



8.Package Dimensions



DIMENSIONS (unit: mm)

Symbol	Min	Тур	Max	Symbol	Min	Тур	Max
Α	0.90	1.01	1.15	A ₁	0.01	0.05	0.10
b _p	0.30	0.42	0.50	С	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
е	-	1.90		e ₁		0.95	
H _E	2.25	2.40	2.55	Lp	0.30	0.42	0.50
Q	0.45	0.49	0.55	v		0.20	
w	-	0.10					



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